

Innovating Energy Technology

FML60N187S2HF

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FUJI POWER MOSFET

Super J MOS® S2 series

N-Channel enhancement mode power MOSFET

Features

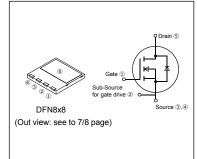
Pb-free lead terminal RoHS compliant Halogen-free molding compound MSL:1, Reflow available

Applications

For switching



Package and Internal circuit chart



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Dunin Course Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Oti	I o	22.7	Α	T _c =25°C Note*1,2
Continuous Drain Current		14.3	Α	Tc=100°C Note*1,2
Pulsed Drain Current	I DP	66.0	Α	Note *2
Gate-Source Voltage	V GS	±30	V	
Non-Repetitive Maximum Avalanche Current	las	2.7	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	391.1	mJ	Note *4
Maximum MOSFET dv/dt	d <i>v</i> ⊳s/d <i>t</i>	50	V/ns	<i>V</i> _{DS} ≤ 600V
Continuous		22.7	Α	T _c =25°C Note*1,2
Diode Forward Current	I DR	14.3	Α	Tc=100°C Note*1,2
Pulsed Diode Forward Current	I DRP	66.0	Α	Note *2
Peak Diode Recovery d <i>v</i> /d <i>t</i>	dv/dt	15	V/ns	Note *5
Peak Diode Recovery -d <i>i</i> _{DR} /d <i>t</i>	-d <i>i</i> _{DR} /d <i>t</i>	100	A/µs	Note *6
Marrian Parray Disabation		127	W	<i>T</i> ₀ =25°C
Maximum Power Dissipation	P tot	2.78	W	<i>T</i> _a =25°C
Operating Channel Temperature	T ch	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Note *1 : Maximum duty cycle D=0.53

Note 1. Maximum duty cycle D=0.50 Note *2 : Limited by maximum channel temperature. Note *3 : $T_{ch} \le 150 \,^{\circ}\text{C}$, See Figure 1 and 2. Note *4 : Starting $T_{ch} = 25 \,^{\circ}\text{C}$, $I_{ch} = 1.7 \,^{\circ}\text{A}$, $I_{ch} = 248 \,^{\circ}\text{mH}$, $I_{ch} = 248 \,^{\circ}\text{C}$, $I_{ch} = 1.7 \,^{\circ}\text{A}$, $I_{ch} = 1.7$

Note *5 : $J_{DR} \le 17.9 \, A$, $-di_{DR}/dt \le 100 \, A/\mu_{S}$, $V_{DS,peak} \le 600 \, V$, $T_{ch} \le 150 \, ^{\circ}C$. Note *6 : $J_{DR} \le 17.9 \, A$, $dv/dt \le 30 \, V/n_{S}$, $V_{DS,peak} \le 600 \, V$, $T_{ch} \le 150 \, ^{\circ}C$.

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■ Electrical Characteristics at T_c =25°C (unless otherwise specified) • Static characteristics

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V J _D = 250 μA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$ $I_D = 0.95 \text{ mA}$		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600 V V _{GS} = 0 V	T _{ch} = 25 °C	-	-	25	μΑ
		V _{DS} = 480 V V _{GS} = 0 V	T _{ch} = 125 °C	-	-	250	
Gate-Source Leakage Current	I GSS	V _{DS} = 0 V V _{GS} = ± 30 V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 4.5 A		-	0.167	0.187	Ω
Gate resistance	r _g	f = 1 MHz, open drain		-	3.2	-	Ω

• Dynamic characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g fs	$V_{DS} = 25 \text{ V}$ $I_D = 9.0 \text{ A}$	3	12	-	S
Input Capacitance	Ciss	V _{DS} = 400 V	-	990	-	
Output Capacitance	Coss	$V_{GS} = 0 \text{ V}$	-	35	-	
Reverse Transfer Capacitance	Crss	f = 250 kHz	-	5.3	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} = 0400 V V _{GS} = 0 V	-	83	-	pF
Effective output capacitance, time related (Note *8)	C _{o(tr)}	V _{DS} = 0400 V V _{GS} = 0 V I _D = constant	-	308	-	
Turn-On Time	t _{d(on)}	$V_{DD} = 400 \text{ V. } V_{GS} = 10 \text{ V}$	-	28	-	
Turn-On Time	t r	$I_{\rm D} = 9.0 \text{A},$	-	14	-	20
Turn-Off Time	t _{d(off)}	$R_{\rm G}$ = 47 Ω See Figure 3 and 4	-	169	-	ns -
	t f		-	22	-	
Total Gate Charge	Q _G	$V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V}$	-	43	-	
Gate-Source Charge	Q _{GS}	$I_b = 17.9 \mathrm{A}$ See Figure 5	-	17	-	nC
Gate-Drain Charge	Q _{GD}		-	16	-	

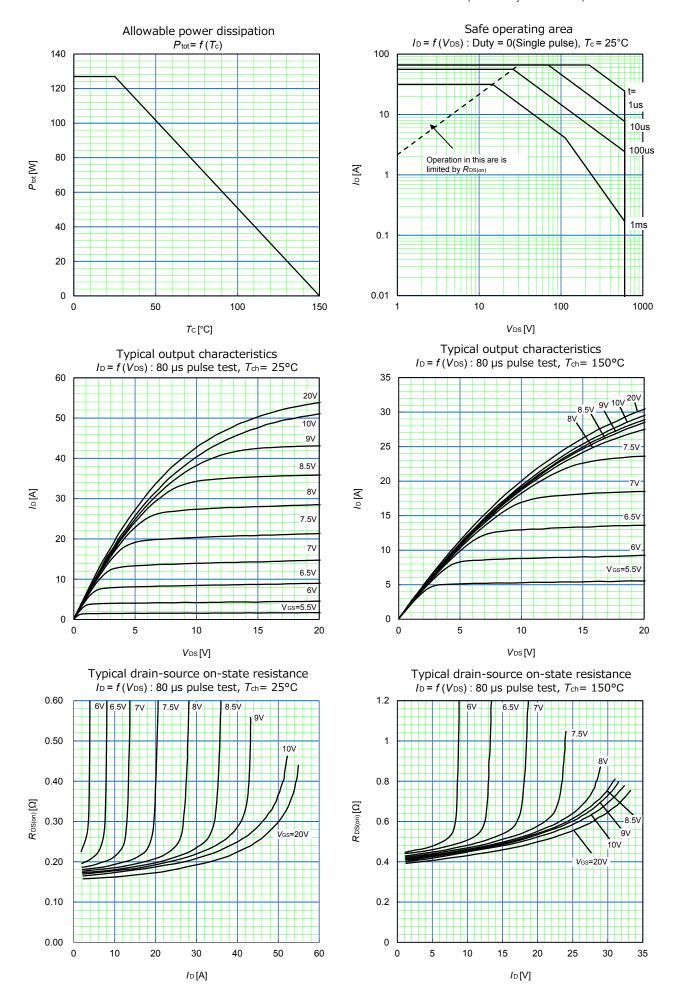
Note *6 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{OS} is rising from 0 to 400V. Note *7 : $C_{\text{o(er)}}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

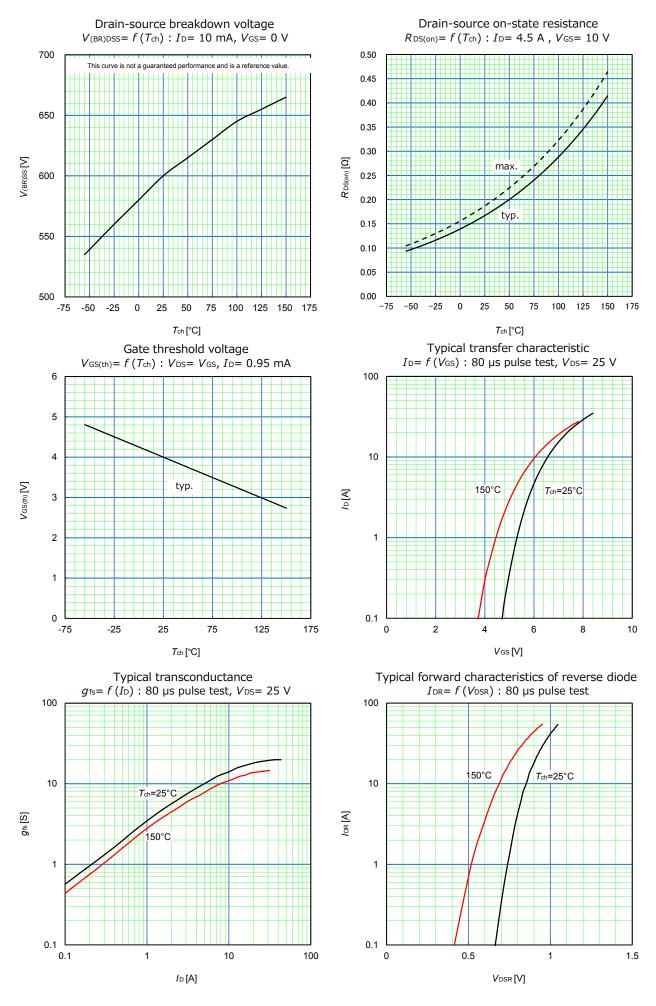
• Reverse diode characteristics

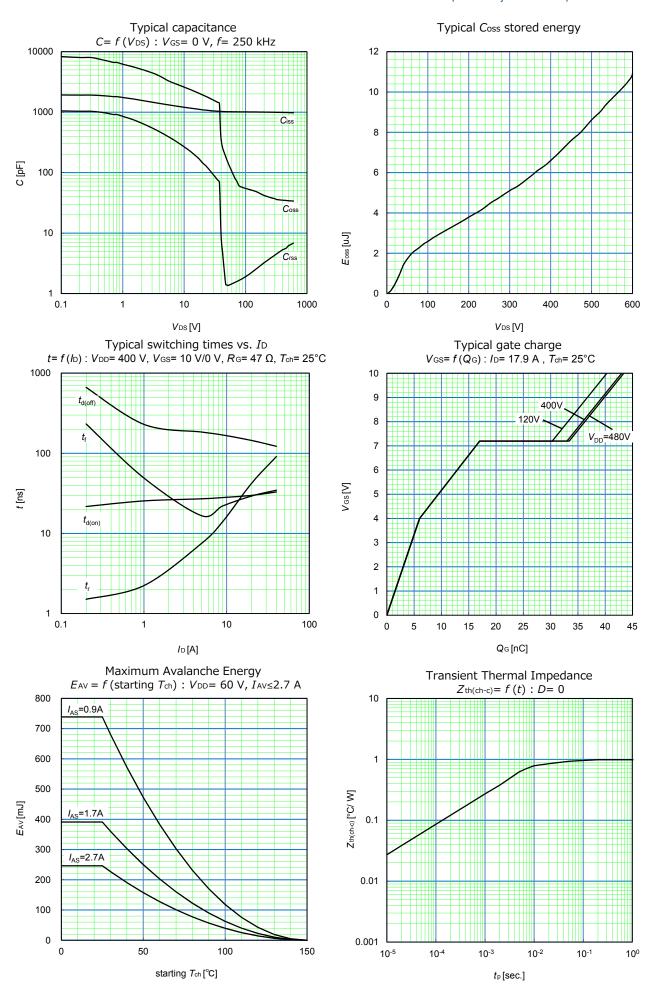
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{DSR}	I _{DR} = 32.8 A, V _{GS} = 0 V T _{ch} = 25 °C	-	1.00	1.35	V
Reverse Recovery Time	t rr	V _{DD} = 400 V I _{DR} = 32.8 A V _{GS} = 0 V -di _{DR} /dt = 100 A/μs	-	285	-	ns
Reverse Recovery Charge	Qrr		-	3.7	-	μC
Peak Reverse Recovery Current	I _{rrm}	7 _{ch} = 25 °C See Figure 6 and 7	-	25	-	Α

■ Thermal Resistance

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Channel – Ambient	Rth(ch-a)	Device mounted on PCB (FR4) Size: 40mm*40mm*1.5mm with 6cm² copper area (one layer, 70µm thickness) for drain connection and cooling.	-	-	45	°C/W
Thermal Resistance, Channel – Case	R _{th(ch-c)}		-	-	0.984	°C/W







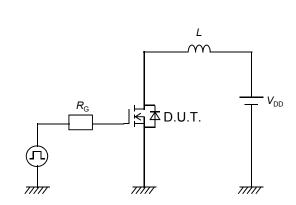


Figure 1. Unclamped inductive load test circuit

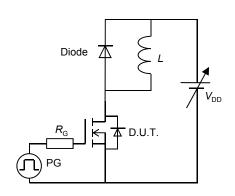


Figure 3. Switching test circuit

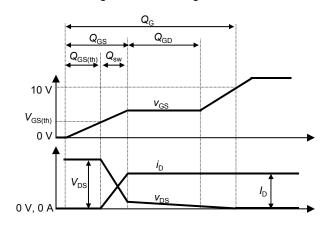


Figure 5. Gate charge waveform

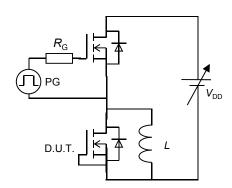


Figure 6. Diode reverse recovery test circuit

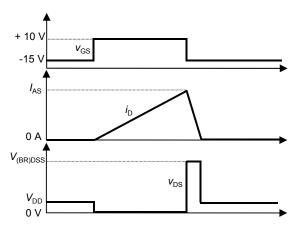


Figure 2. Unclamped inductive waveform

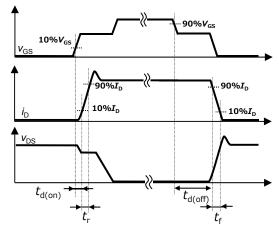


Figure 4. Switching times waveform

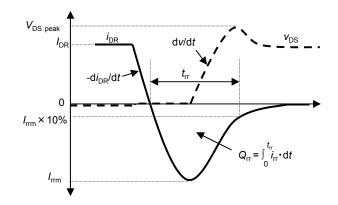
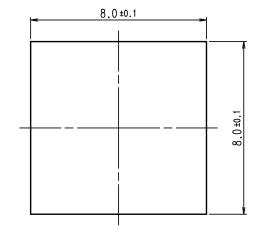
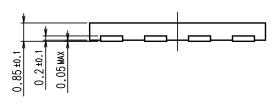


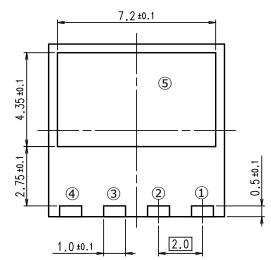
Figure 7. Diode reverse recovery waveform

■ Package Dimensions : DFN8x8 Package









CONNECTION

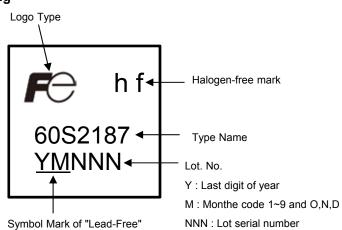
- ① Gate
- 2 Sub-Source for Gate Drive
- 3,4 Source
- **5** DRAIN

DIMENSIONS ARE IN MILLIMETERS

Notes

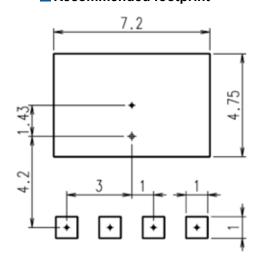
- 1.(): Reference dimensions.
- The metal part is covered with the solder plating, part of cutting is without the solder plating.

Marking



* The font (font type,size) and the trademark-size might be actually different.

Recommended footprint



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